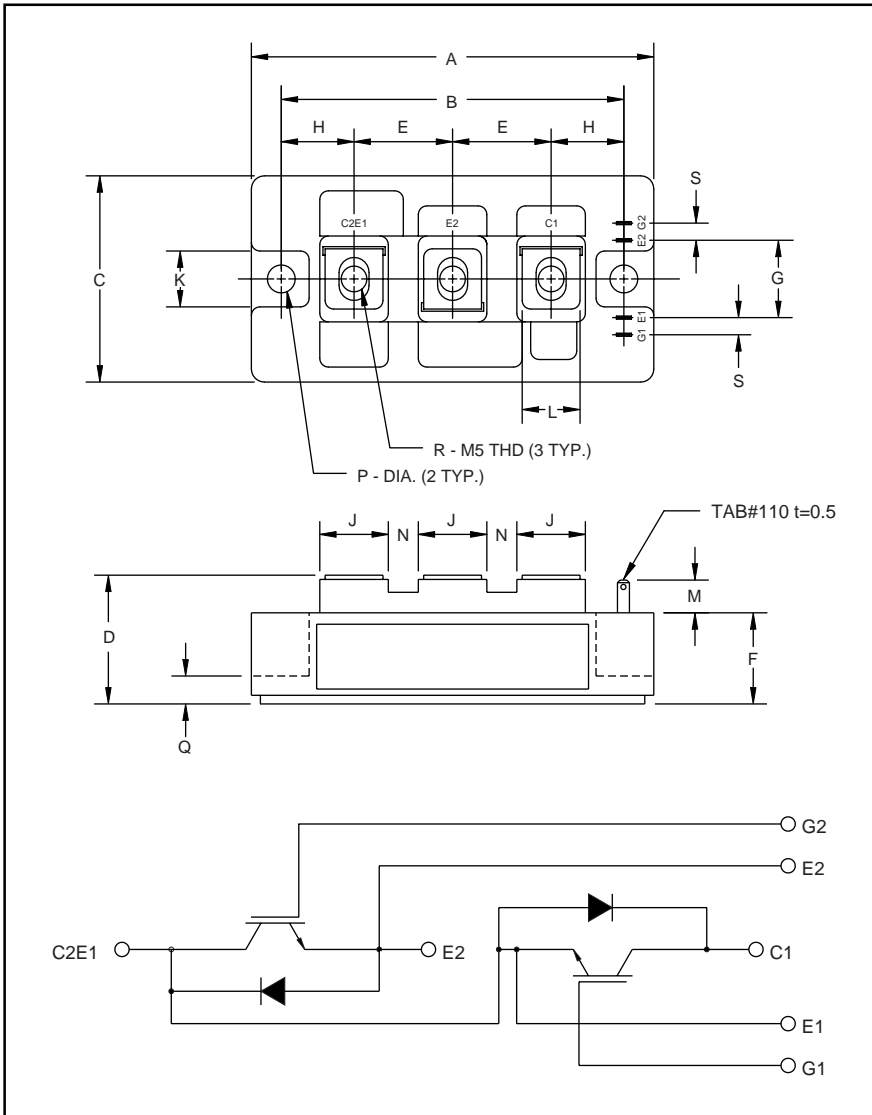


MITSUBISHI IGBT MODULES
CM200DY-12H
 HIGH POWER SWITCHING USE
 INSULATED TYPE



Outline Drawing and Circuit Diagram

| Dimensions | Inches | Millimeters |
|------------|------------|-------------|
| A | 3.70 | 94.0 |
| B | 3.150±0.01 | 80.0±0.25 |
| C | 1.89 | 48.0 |
| D | 1.18 Max. | 30.0 Max. |
| E | 0.90 | 23.0 |
| F | 0.83 | 21.2 |
| G | 0.71 | 18.0 |
| H | 0.67 | 17.0 |
| J | 0.63 | 16.0 |

| Dimensions | Inches | Millimeters |
|------------|------------|-------------|
| K | 0.51 | 13.0 |
| L | 0.47 | 12.0 |
| M | 0.30 | 7.5 |
| N | 0.28 | 7.0 |
| P | 0.256 Dia. | Dia. 6.5 |
| Q | 0.31 | 8.0 |
| R | M5 Metric | M5 |
| S | 0.16 | 4.0 |

Description:

Mitsubishi IGBT Modules are designed for use in switching applications. Each module consists of two IGBTs in a half-bridge configuration with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- Low Drive Power
- Low $V_{CE(sat)}$
- Discrete Super-Fast Recovery Free-Wheel Diode
- High Frequency Operation
- Isolated Baseplate for Easy Heat Sinking

Applications:

- AC Motor Control
- Motion/Servo Control
- UPS
- Welding Power Supplies

Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM200DY-12H is a 600V (V_{CES}), 200 Ampere Dual IGBT Module.

| Type | Current Rating Amperes | V_{CES} Volts (x 50) |
|------|---------------------------|---------------------------|
| CM | 200 | 12 |

CM200DY-12H

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| Ratings | Symbol | CM200DY-12H | Units |
|---|------------------|-------------|------------------|
| Junction Temperature | T_j | -40 to 150 | $^\circ\text{C}$ |
| Storage Temperature | T_{stg} | -40 to 125 | $^\circ\text{C}$ |
| Collector-Emitter Voltage (G-E SHORT) | V_{CES} | 600 | Volts |
| Gate-Emitter Voltage (C-E SHORT) | V_{GES} | ± 20 | Volts |
| Collector Current ($T_C = 25\text{ }^\circ\text{C}$) | I_C | 200 | Amperes |
| Peak Collector Current | I_{CM} | 400* | Amperes |
| Emitter Current** ($T_C = 25\text{ }^\circ\text{C}$) | I_E | 200 | Amperes |
| Peak Emitter Current** | I_{EM} | 400* | Amperes |
| Maximum Collector Dissipation ($T_C = 25\text{ }^\circ\text{C}$, $T_j \leq 150\text{ }^\circ\text{C}$) | P_c | 780 | Watts |
| Mounting Torque, M5 Main Terminal | - | 1.47 ~ 1.96 | N · m |
| Mounting Torque, M6 Mounting | - | 1.96 ~ 2.94 | N · m |
| Weight | - | 270 | Grams |
| Isolation Voltage (Main Terminal to Baseplate, AC 1 min.) | V_{iso} | 2500 | Vrms |

*Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed $T_{j(\text{max})}$ rating.

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

Static Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|--------------------------------------|----------------------|--|------|------|-------|---------------|
| Collector-Cutoff Current | I_{CES} | $V_{\text{CE}} = V_{\text{CES}}$, $V_{\text{GE}} = 0\text{V}$ | - | - | 1.0 | mA |
| Gate Leakage Current | I_{GES} | $V_{\text{GE}} = V_{\text{GES}}$, $V_{\text{CE}} = 0\text{V}$ | - | - | 0.5 | μA |
| Gate-Emitter Threshold Voltage | $V_{\text{GE(th)}}$ | $I_C = 20\text{mA}$, $V_{\text{CE}} = 10\text{V}$ | 4.5 | 6.0 | 7.5 | Volts |
| Collector-Emitter Saturation Voltage | $V_{\text{CE(sat)}}$ | $I_C = 200\text{A}$, $V_{\text{GE}} = 15\text{V}$ | - | 2.1 | 2.8** | Volts |
| | | $I_C = 200\text{A}$, $V_{\text{GE}} = 15\text{V}$, $T_j = 150\text{ }^\circ\text{C}$ | - | 2.15 | - | Volts |
| Total Gate Charge | Q_G | $V_{\text{CC}} = 300\text{V}$, $I_C = 200\text{A}$, $V_{\text{GE}} = 15\text{V}$ | - | 600 | - | nC |
| Emitter-Collector Voltage | V_{EC} | $I_E = 200\text{A}$, $V_{\text{GE}} = 0\text{V}$ | - | - | 2.8 | Volts |

** Pulse width and repetition rate should be such that device junction temperature rise is negligible.

Dynamic Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units | |
|-------------------------------|---------------------|---|---------------------|------|------|---------------|----|
| Input Capacitance | C_{ies} | | - | - | 20 | nF | |
| Output Capacitance | C_{oes} | $V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 10\text{V}$ | - | - | 7 | nF | |
| Reverse Transfer Capacitance | C_{res} | | - | - | 4 | nF | |
| Resistive | Turn-on Delay Time | $V_{\text{CC}} = 300\text{V}$, $I_C = 200\text{A}$, $V_{\text{GE1}} = V_{\text{GE2}} = 15\text{V}$, $R_G = 3.1\Omega$ | - | - | 200 | ns | |
| Load | Rise Time | | t_r | - | - | 550 | ns |
| Switching | Turn-off Delay Time | | $t_{\text{d(off)}}$ | - | - | 300 | ns |
| Times | Fall Time | | t_f | - | - | 300 | ns |
| Diode Reverse Recovery Time | t_{rr} | $I_E = 200\text{A}$, $di_E/dt = -400\text{A}/\mu\text{s}$ | - | - | 110 | ns | |
| Diode Reverse Recovery Charge | Q_{rr} | $I_E = 200\text{A}$, $di_E/dt = -400\text{A}/\mu\text{s}$ | - | 0.54 | - | μC | |

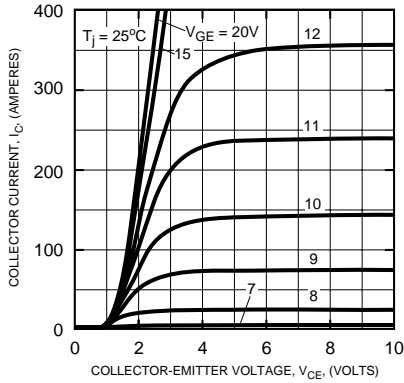
Thermal and Mechanical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

| Characteristics | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|--------------------------------------|----------------------|------------------------------------|------|------|-------|---------------------------|
| Thermal Resistance, Junction to Case | $R_{\text{th(j-c)}}$ | Per IGBT | - | - | 0.16 | $^\circ\text{C}/\text{W}$ |
| Thermal Resistance, Junction to Case | $R_{\text{th(j-c)}}$ | Per FWDi | - | - | 0.35 | $^\circ\text{C}/\text{W}$ |
| Contact Thermal Resistance | $R_{\text{th(c-f)}}$ | Per Module, Thermal Grease Applied | - | - | 0.065 | $^\circ\text{C}/\text{W}$ |

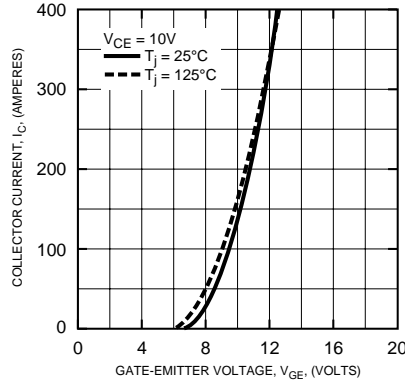
CM200DY-12H

HIGH POWER SWITCHING USE
INSULATED TYPE

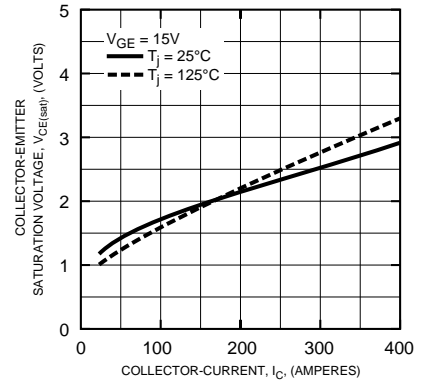
OUTPUT CHARACTERISTICS (TYPICAL)



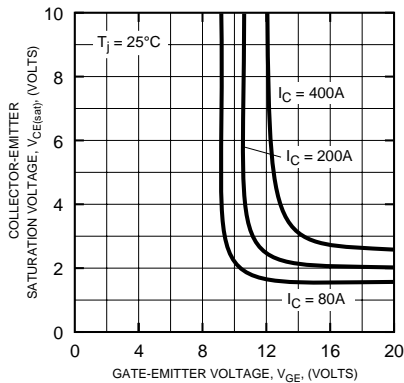
TRANSFER CHARACTERISTICS (TYPICAL)



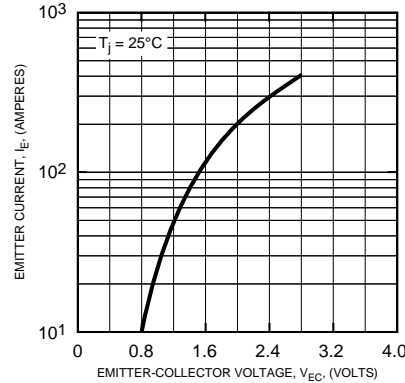
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



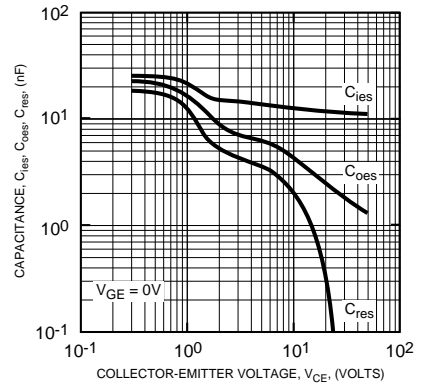
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



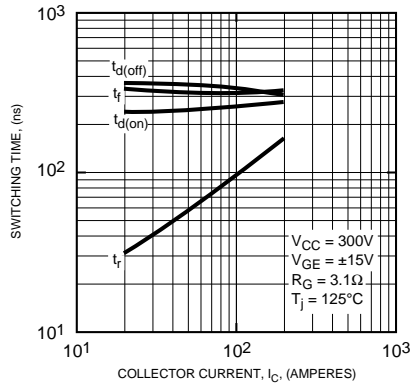
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



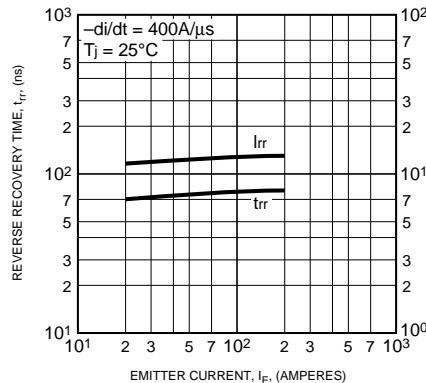
CAPACITANCE VS. V_{CE} (TYPICAL)



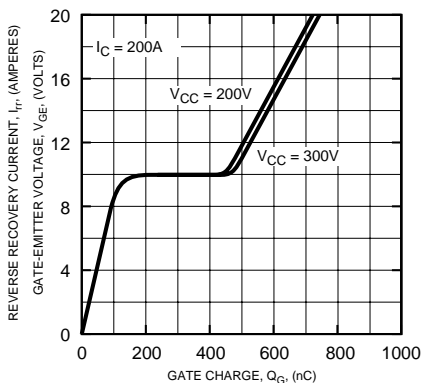
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



GATE CHARGE, V_{GE}



CM200DY-12H

HIGH POWER SWITCHING USE
INSULATED TYPE

